

Amendments to the Specification

Please replace paragraph [0061] with the following amended paragraph:

(Second Embodiment)

FIGs. 7(A) to 8 illustrate a method of manufacturing a semiconductor device (e.g. an optical ~~deice~~ device) according to a second embodiment of the present invention. FIG. 8 is a plan view of a cover 120 and the semiconductor substrate 20 facing each other.